NEC

MOS INTEGRATED CIRCUIT
μPD72874

IEEE1394 OHCI 1.1 COMPLIANT 3PORT PHY-LINK 1-CHIP HOST CONTROLLER

The μPD72874 is the LSI that integrated OHCI-Link and PHY function into a single chip. The μPD72874 complies with the 1394 OHCI Specification 1.1 and the IEEE Std 1394a-2000 specifications, and works up to 400 Mbps.
It makes design so compact for PC and PC card application.

FEATURES

- Compliant with Link Layer Services as defined in 1394 Open Host Controller Interface specification release 1.1
- Compliant with Physical Layer Services as defined in IEEE Std 1394a-2000
- Provides three cable ports at 100/200/400 Mbps
- Super Low power consumption for Physical Layer
- Compliant with protocol enhancement as defined in IEEE Std1394a-2000
- Modular 32-bit host interface compliant to PCI Specification release 2.2
- Supports PCI-Bus Power Management Interface Specification release 1.1
- Modular 32-bit host interface compliant to Card Bus Specification
- Cycle Master and Isochronous Resource Manager capable
- Built-in FIFOs for isochronous transmit (2048 bytes), asynchronous transmit (2048 bytes), and receive (3072 bytes)
- Supports D0, D1, D2, D3hot
- Supports wake up function from D3cold
- 32-bit CRC generation and checking for receive/transmit packets
- 4 isochronous transmit DMAs and 4 isochronous receive DMAs supported
- 32-bit DMA channels for physical memory read/write
- Clock generation by 24.576 MHz X'tal
- 2-wire Serial EEPROM™ interface supported
- Separate power supply Link and PHY
- Programmable latency timer from serial EEPROM in Cardbus mode (CARD_ON = 1)

ORDERING INFORMATION

Part number	Package
μPD72874GC-YEB	120-pin plastic TQFP (Fine pitch) (14 x 14)

★

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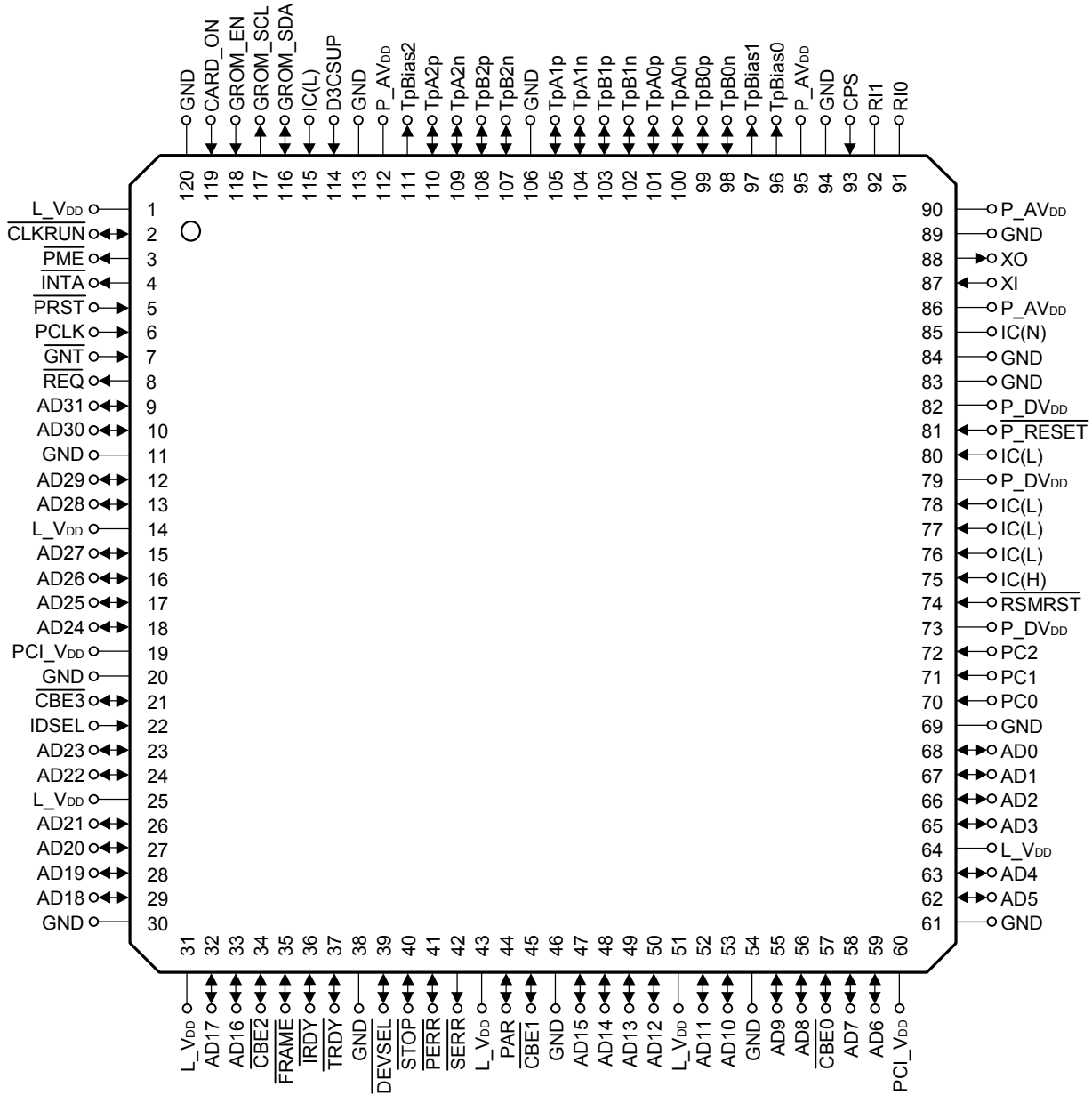
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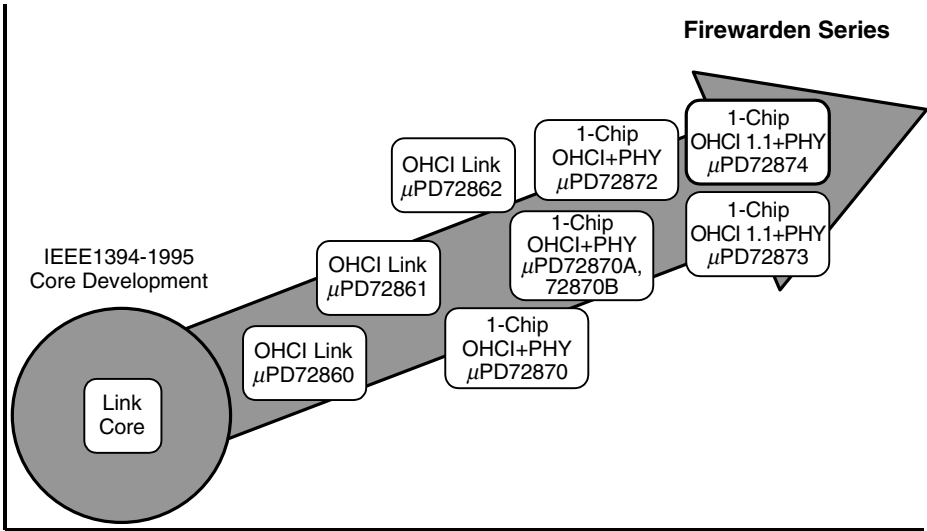
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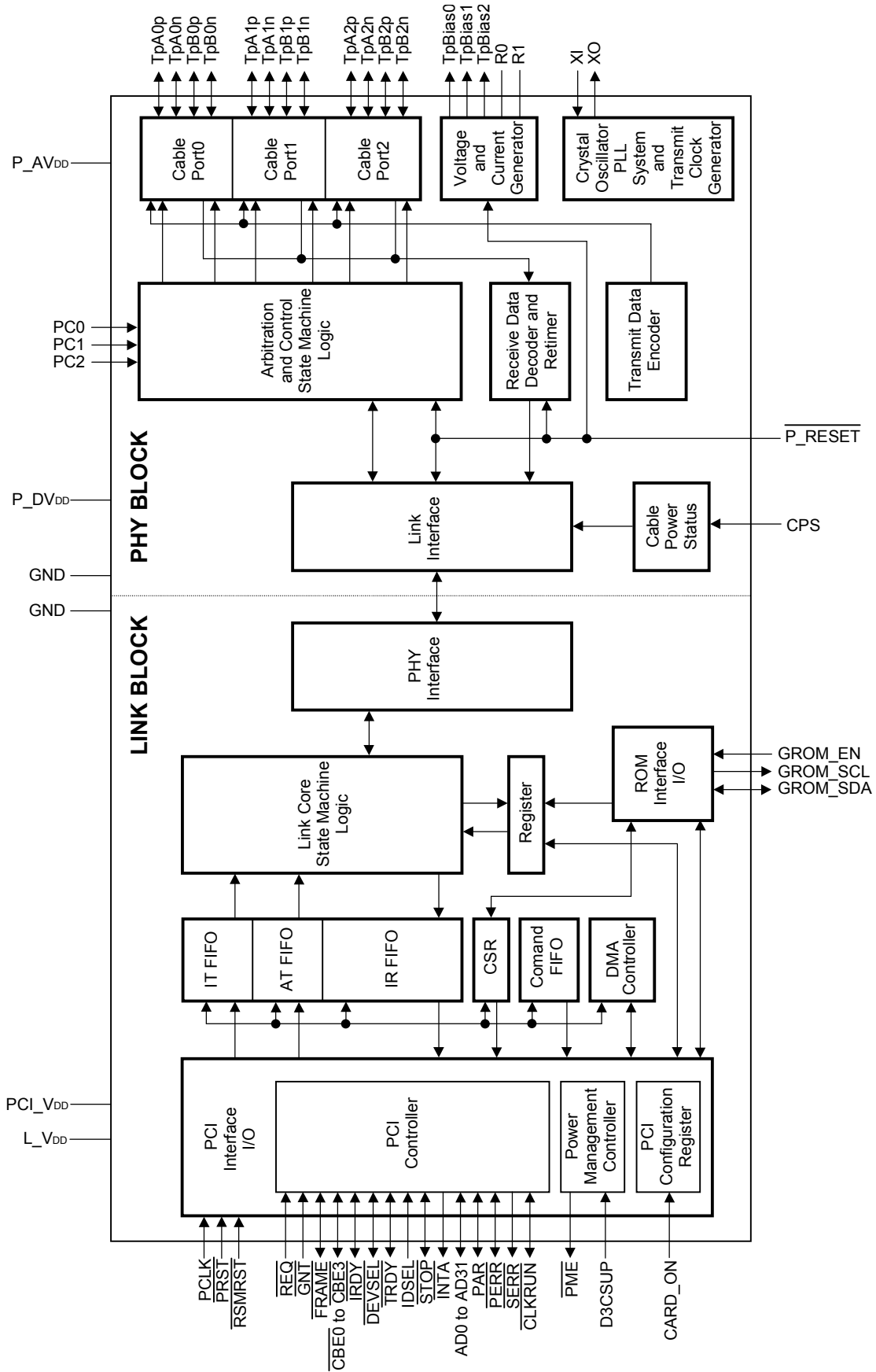
★ **PIN CONFIGURATION (TOP VIEW)**

- **120-pin plastic TQFP (Fine pitch) (14 x 14)**

*μ*PD72874GC-YEB

Top pins (120–91): GND, CARD_ON, GROM_EN, GROM_SCL, GROM_SDA, IC(L), D3CSUP, GND, P_AV$_{DD}$, TpBias2, TpA2p, TpA2n, TpB2p, TpB2n, GND, TpA1p, TpA1n, TpB1p, TpB1n, TpA0p, TpA0n, TpB0p, TpB0n, TpBias1, TpBias0, P_AV$_{DD}$, GND, CPS, RI1, RI0

Left pins (1–30):
Pin	Signal
1	L_V$_{DD}$
2	CLKRUN
3	PME
4	INTA
5	PRST
6	PCLK
7	GNT
8	REQ
9	AD31
10	AD30
11	GND
12	AD29
13	AD28
14	L_V$_{DD}$
15	AD27
16	AD26
17	AD25
18	AD24
19	PCI_V$_{DD}$
20	GND
21	CBE3
22	IDSEL
23	AD23
24	AD22
25	L_V$_{DD}$
26	AD21
27	AD20
28	AD19
29	AD18
30	GND

Right pins (90–61):
Pin	Signal
90	P_AV$_{DD}$
89	GND
88	XO
87	XI
86	P_AV$_{DD}$
85	IC(N)
84	GND
83	GND
82	P_DV$_{DD}$
81	P_RESET
80	IC(L)
79	P_DV$_{DD}$
78	IC(L)
77	IC(L)
76	IC(L)
75	IC(H)
74	RSMRST
73	P_DV$_{DD}$
72	PC2
71	PC1
70	PC0
69	GND
68	AD0
67	AD1
66	AD2
65	AD3
64	L_V$_{DD}$
63	AD4
62	AD5
61	GND

Bottom pins (31–60): L_V$_{DD}$, AD17, AD16, CBE2, FRAME, IRDY, TRDY, GND, DEVSEL, STOP, PERR, SERR, L_V$_{DD}$, PAR, CBE1, GND, AD15, AD14, AD13, AD12, L_V$_{DD}$, AD11, AD10, GND, AD9, AD8, CBE0, AD7, AD6, PCI_V$_{DD}$

PIN NAME

AD0 to AD31	: PCI Multiplexed Address and Data	P_AV$_{DD}$	: PHY Analog V$_{DD}$
CARD_ON	: PCI/Card Select	P_DV$_{DD}$	: PHY Digital V$_{DD}$
$\overline{CBE0}$ to $\overline{CBE3}$	: Command/Byte Enables	$\overline{P\_RESET}$	: PHY Power on Reset Input
$\overline{CLKRUN}$	: PCICLK Running	$\overline{REQ}$	: Bus_master Request
CPS	: Cable Power Status Input	RI0	: Resistor0 for Reference Current Setting
D3CSUP	: D3cold Support	RI1	: Resistor1 for Reference Current Setting
$\overline{DEVSEL}$	: Device Select	$\overline{RSMRST}$	: Resume Reset
$\overline{FRAME}$	: Cycle Frame	$\overline{SERR}$	: System Error
GND	: GND	$\overline{STOP}$	: PCI Stop
$\overline{GNT}$	: Bus_master Grant	TpA0n	: Port-1 Twisted Pair A Negative Input/Output
GROM_EN	: Serial EEPROM Enable	TpA0p	: Port-1 Twisted Pair A Positive Input/Output
GROM_SCL	: Serial EEPROM Clock Output	TpA1n	: Port-2 Twisted Pair A Negative Input/Output
GROM_SDA	: Serial EEPROM Data Input / Output	TpA1p	: Port-2 Twisted Pair A Positive Input/Output
IC(H)	: Internally Connected (High Clamped)	TpA2n	: Port-3 Twisted Pair A Negative Input/Output
IC(L)	: Internally Connected (Low Clamped)	TpA2p	: Port-3 Twisted Pair A Positive Input/Output
IC(N)	: Internally Connected (Open)	TpB0n	: Port-1 Twisted Pair B Negative Input/Output
IDSEL	: ID Select	TpB0p	: Port-1 Twisted Pair B Positive Input/Output
$\overline{INTA}$	: Interrupt	TpB1n	: Port-2 Twisted Pair B Negative Input/Output
$\overline{IRDY}$	: Initiator Ready	TpB1p	: Port-2 Twisted Pair B Positive Input/Output
L_V$_{DD}$	: V$_{DD}$ for Link Digital Core and Link I/Os	TpB2n	: Port-3 Twisted Pair B Negative Input/Output
PAR	: Parity	TpB2p	: Port-3 Twisted Pair B Positive Input/Output
PC0 to PC2	: Power Class Input	TpBias0	: Port-1 Twisted Pair Bias Voltage Output
PCI_V$_{DD}$	: V$_{DD}$ for PCI I/Os	TpBias1	: Port-2 Twisted Pair Bias Voltage Output
PCLK	: PCI Clock	TpBias2	: Port-3 Twisted Pair Bias Voltage Output
$\overline{PERR}$	: Parity Error	$\overline{TRDY}$	: Target Ready
$\overline{PME}$	: PME Output	XI	: X'tal XI
$\overline{PRST}$	: Reset	XO	: X'tal XO

CONTENTS

1. PIN FUNCTIONS

1.1 PCI/Cardbus Interface Signals: (52 pins)

(1/2)

Name	I/O	Pin No.	I_{OL}	Volts(V)	Function	Block *
PAR	I/O	44	PCI/Cardbus	5/3.3	**Parity** is even parity across AD0 to AD31 and $\overline{CBE0}$ to $\overline{CBE3}$. It is an input when AD0 to AD31 is an input; it is an output when AD0 to AD31 is an output.	Link
AD0 to AD31	I/O	9, 10, 12, 13, 15 to18, 23, 24, 26 to 29, 32, 33, 47 to 50, 52, 53, 55, 56, 58, 59, 62, 63, 65 to 68	PCI/Cardbus	5/3.3	**PCI Multiplexed Address and Data**	Link
$\overline{CBE0}$ to $\overline{CBE3}$	I/O	21, 34, 45, 57	-	5/3.3	**Command/Byte Enables** are multiplexed bus commands & byte enables.	Link
$\overline{FRAME}$	I/O	35	PCI/Cardbus	5/3.3	**Frame** is asserted by the initiator to indicate the cycle beginning and is kept asserted during the burst cycle. If Cardbus mode (CARD_ON = 1), this pin should be pulled up to V_{DD}.	Link
$\overline{TRDY}$	I/O	37	PCI/Cardbus	5/3.3	**Target Ready** indicates that the current data phase of the transaction is ready to be completed.	Link
$\overline{IRDY}$	I/O	36	PCI/Cardbus	5/3.3	**Initiator Ready** indicates that the current bus master is ready to complete the current data phase. During a write, its assertion indicates that the initiator is driving valid data onto the data bus. During a read, its assertion indicates that the initiator is ready to accept data from the currently-addressed target.	Link
$\overline{REQ}$	O	8	PCI/Cardbus	5/3.3	**Bus_master Request** indicates to the bus arbiter that this device wants to become a bus master.	Link
$\overline{GNT}$	I	7	-	5/3.3	**Bus_master Grant** indicates to this device that access to the bus has been granted.	Link
IDSEL	I	22	-	5/3.3	**Initialization Device Select** is used as chip select for configuration read/write transaction during the phase of device initialization. If Cardbus mode (CARD_ON = 1), this pin should be pulled up to V_{DD}.	Link
$\overline{DEVSEL}$	I/O	39	PCI/Cardbus	5/3.3	**Device Select** when actively driven, indicates that the driving device has decoded its address as the target of the current access.	Link
$\overline{STOP}$	I/O	40	PCI/Cardbus	5/3.3	**PCI Stop** when actively driven, indicates that the target is requesting the current bus master to stop the transaction.	Link
$\overline{PME}$	O	3	PCI/Cardbus	5/3.3	**PME Output** for power management event.	Link

Remark *: If the Link pin is pulled up, it should be connected to L_V_{DD}.

(2/2)

Name	I/O	Pin No.	I$_{OL}$	Volts(V)	Function	Block *
CLKRUN	I/O	2	PCI/Cardbus	5/3.3	**PCICLK Running** as input, to determine the status of PCLK; as output, to request starting or speeding up clock.	Link
INTA	O	4	PCI/Cardbus	5/3.3	**Interrupt** the PCI interrupt request A.	Link
PERR	I/O	41	PCI/Cardbus	5/3.3	**Parity Error** is used for reporting data parity errors during all PCI transactions, except a special cycle. It is an output when AD0 to AD31 and PAR are both inputs. It is an input when AD0 to AD31 and PAR are both outputs.	Link
SERR	O	42	PCI/Cardbus	5/3.3	**System Error** is used for reporting address parity errors, data parity errors during the special cycle, or any other system error where the effect can be catastrophic. When reporting address parity errors, it is an output.	Link
PRST	I	5	-	5/3.3	**Reset** PCI reset	Link
PCLK	I	6	-	5/3.3	**PCI Clock** 33 MHz system bus clock.	Link

Remark   *: If the Link pin is pulled up, it should be connected to L_V$_{DD}$.

1.2 PHY Signals: (20 pins)

Name	I/O	Pin No.	I_{OL}	Volts(V)	Function	Block *
TpA0p	I/O	101	-	-	**Port-1 Twisted Pair A Positive Input/Output** [Note 1]	PHY Analog
TpA0n	I/O	100	-	-	**Port-1 Twisted Pair A Negative Input/Output** [Note 1]	PHY Analog
TpB0p	I/O	99	-	-	**Port-1 Twisted Pair B Positive Input/Output** [Note 1]	PHY Analog
TpB0n	I/O	98	-	-	**Port-1 Twisted Pair B Negative Input/Output** [Note 1]	PHY Analog
TpA1p	I/O	105	-	-	**Port-2 Twisted Pair A Positive Input/Output** [Note 1]	PHY Analog
TpA1n	I/O	104	-	-	**Port-2 Twisted Pair A Negative Input/Output** [Note 1]	PHY Analog
TpB1p	I/O	103	-	-	**Port-2 Twisted Pair B Positive Input/Output** [Note 1]	PHY Analog
TpB1n	I/O	102	-	-	**Port-2 Twisted Pair B Negative Input/Output** [Note 1]	PHY Analog
TpA2p	I/O	110	-	-	**Port-3 Twisted Pair A Positive Input/Output** [Note 1]	PHY Analog
TpA2n	I/O	109	-	-	**Port-3 Twisted Pair A Negative Input/Output** [Note 1]	PHY Analog
TpB2p	I/O	108	-	-	**Port-3 Twisted Pair B Positive Input/Output** [Note 1]	PHY Analog
TpB2n	I/O	107	-	-	**Port-3 Twisted Pair B Negative Input/Output** [Note 1]	PHY Analog
CPS	I	93	-	-	**Cable Power Status Input** [Note2]	PHY Digital
TpBias0	O	96	-	-	**Port-1 Twisted Pair Bias Voltage Output** [Note 1]	PHY Analog
TpBias1	O	97	-	-	**Port-2 Twisted Pair Bias Voltage Output** [Note 1]	PHY Analog
TpBias2	O	111	-	-	**Port-3 Twisted Pair Bias Voltage Output** [Note 1]	PHY Analog
RI0	-	91	-	-	**Resistor0 for Reference Current Setting** [Note 3]	PHY Analog
RI1	-	92	-	-	**Resistor1 for Reference Current Setting** [Note 3]	PHY Analog
XI	I	87	-	-	**X'tal XI**	PHY Analog
XO	O	88	-	-	**X'tal XO**	PHY Analog

Notes 1. If unused port, please refer to **4.1.4 Unused Ports**.

      2. Please refer to **4.1.3 CPS**.

      3. Please refer to **4.5 RI0, RI1**.

Remark *: If the PHY Digital pin is pulled up, it should be connected to P_DV$_{DD}$.

            If the PHY Analog pin is pulled up, it should be connected to P_AV$_{DD}$.

1.3 PHY Control Signals: (4 pins)

Name	I/O	Pin No.	I_{OL}	Volts(V)	Function	Block *
PC0 to PC2	I	70 to 72	-	3.3	**Power Class Input** [Note 1]	PHY Digital
P_RESET	I	81	-	-	**PHY Power on Reset Input** [Note 2]	PHY Digital

Notes 1. Please refer to **4.3 PC0 to PC2**.

      2. Please refer to **4.4 P_RESET**.

Remark *: If the PHY Digital pin is pulled up, it should be connected to P_DV$_{DD}$.

1.4 PCI/Cardbus Select Signal: (1 pin)

Name	I/O	Pin No.	I_{OL}	Volts(V)	Function	Block *
CARD_ON	I	119	-	3.3	**PCI/CardBus Select** 1:Cardbus mode 0:PCI bus mode	Link

Remark *: If the Link pin is pulled up, it should be connected to L_V$_{DD}$.

1.5 Serial ROM Interface Signals: (3 pins)

Name	I/O	Pin No.	I_OL	Volts(V)	Function	Block *
GROM_SDA	I/O	116	6 mA	3.3	**Serial EEPROM Data Input / Output**	Link
GROM_SCL	O	117	6 mA	3.3	**Serial EEPROM Clock Output**	Link
GROM_EN	I	118	-	3.3	**Serial EEPROM Enable** 1: GUID Load enable 0: GUID Load disable	Link

Remark *: If the Link pin is pulled up, it should be connected to L_V_DD.

★   ### 1.6 D3cold Wake Up Function Signals: (2 pins)

Name	I/O	Pin No.	I_OL	Volts(V)	Function	Block *
D3CSUP	I	114	-	5/3.3	**D3cold Support** 1: D3cold wake up enable 0: D3cold wake up disable	Link
$\overline{\text{RSMRST}}$	I	74	-	5/3.3	**Resume Reset** D3cold support (114 pin) = '1' As this mode supports D3cold wake up, $\overline{\text{RSMRST}}$ must connect system $\overline{\text{RSMRST}}$ signal. D3cold support (114 pin) = '0' As this mode is the µPD72872 compatible, $\overline{\text{RSMRST}}$ clamp to '1'.	Link

Remark *: If the Link pin is pulled up, it should be connected to L_V_DD.

1.7 IC: (7 pins)

Name	I/O	Pin No.	I_OL	Volts(V)	Function	Block *
★ IC(H)	I	75	-	-	**Internally Connected** (High clamped)	Link
IC(L)	I	76 to 78, 80, 115	-	-	**Internally Connected** (Low clamped)	-
IC(N)	-	85	-	-	**Internally Connected** (Open)	-

Remark *: If the Link pin is pulled up, it should be connected to L_V_DD.

1.8 V_DD

Name	I/O	Pin No.	I_OL	Volts(V)	Function	Block *
PCI_V_DD	-	19, 60	-	5/3.3	**V_DD for PCI I/Os**	Link
L_V_DD	-	1, 14, 25, 31, 43, 51, 64	-	3.3	**V_DD for Link digital Core and Link I/Os** To use D3cold wake up function, L_V_DD must switch V_DD to Vaux when the system suspend.	Link
P_DV_DD	-	73, 79, 82	-	3.3	**PHY digital V_DD**	PHY Digital
P_AV_DD	-	86, 90, 95, 112	-	3.3	**PHY Analog V_DD**	PHY Analog

Remark *: If the Link pin is pulled up, it should be connected to L_V_DD.

If the PHY Digital pin is pulled up, it should be connected to P_DV_DD.

If the PHY Analog pin is pulled up, it should be connected to P_AV_DD.

1.9 GND

Name	I/O	Pin No.	I_OL	Volts(V)	Function	Block
GND	-	11, 20, 30, 38, 46, 54, 61, 69, 83, 84, 89, 94, 106, 113, 120	-	-	**GND**	-

2. PHY REGISTERS

2.1 Complete Structure for PHY Registers

Figure 2-1. Complete Structure of PHY Registers

	0	1	2	3	4	5	6	7
0000	Physical_ID						R	PS
0001	RHB	IBR	Gap_count					
0010	Extended (7)			Reserved	Total_ports			
0011	Max_speed			Reserved	Delay			
0100	Link_active	Contender	Jitter			Pwr_class		
0101	Watchdog	ISBR	Loop	Pwr_fail	Timeout	Port_event	Enab_accel	Enab_multi
0110	Reserved							
0111	Page_select			Reserved	Port_select			
1000	Register0 (page_select)							
1001	Register1 (page_select)							
1010	Register2 (page_select)							
1011	Register3 (page_select)							
1100	Register4 (page_select)							
1101	Register5 (page_select)							
1110	Register6 (page_select)							
1111	Register7 (page_select)							

Table 2-1. Bit Field Description (1/3)

Field	Size	R/W	Reset value	Description
Physical_ID	6	R	000000	Physical_ID value selected from Self_ID period.
R	1	R	0	If this bit is 1, the node is root. 1: Root 0: Not root
PS	1	R		Cable power status. 1: Cable power on 0: Cable power off
RHB	1	R/W	0	Root Hold -off bit. If 1, becomes root at the bus reset.
IBR	1	R/W	0	Initiate bus reset. Setting to 1 begins a long bus reset. Long bus reset signal duration: 166 *μ*sec. Returns to 0 at the beginning of bus reset.
Gap_count	6	R/W	111111	Gap count value. It is updated by the changes of transmitting and receiving the PHY configuration packet Tx/Rx. The value is maintained after first bus reset. After the second bus reset it returns to reset value.
Extended	3	R	111	Shows the extended register map.

Table 2-1. Bit Field Description (2/3)

Field	Size	R/W	Reset value	Description
Total_ports	4	R	0011	Supported port number. 0011: 3 ports
Max_speed	3	R	010	Indicate the maximum speed that this node supports. 010: 98.304, 196.608 and 393.216 Mbps
Delay	4	R	0000	Indicate worst case repeating delay time. 144 + (Delay x 20) = 144 nsec
Link_active	1	R/W	1	Link active. 1: Enable 0: Disable The logical AND status of this bit and LPS. State will be referred to "L bit" of Self-ID Packet#0. The LPS is a PHY/Link interface signal and is defined in P1394a-2000. It is an internal signal in the μPD72874.
Contender	1	R/W	0	Contender. "1" indicate this node support bus manager function. This bit will be referred to "C bit" of Self-ID Packet#0.
Jitter	3	R	010	The difference of repeating time (Max.-Min.). (2+1) x 20=60 nsec
Pwr_class	3	R/W	See Description	Power class. Please refer to IEEE1394a-2000 [4.3.4.1]. This bit will be referred to Pwr field of Self-ID Packet#0.
Watchdog	1	R/W	0	Watchdog Enable. This bit serves two purposes. When set to 1, if any one port does resume, the Port_event bit becomes 1. To determine whether or not an interrupt condition shall be indicated to the link. On condition of LPS = 0 and Watchdog = 0, LKON as interrupt of Loop, Pwr_fail, Timeout is not output.
ISBR	1	R/W	0	Initiate short (arbitrated) bus reset. Setting to 1 acquires the bus and begins short bus reset. Short bus reset signal output : 1.3 μsec Returns to 0 at the beginning of the bus reset.
Loop	1	R/W	0	Loop detection output. 1: Detection Writing 1 to this bit clears it to 0. Writing 0 has no effect.
Pwr_fail	1	R/W	1	Power cable disconnect detect. It becomes 1 when there is a change from 1 to 0 in the CPS bit. Writing 1 to this bit clears it to 0. Writing 0 has no effect.

Table 2-1. Bit Field Description (3/3)

Field	Size	R/W	Reset value	Description
Timeout	1	R/W	0	Arbitration state machine time-out. Writing 1 to this bit clears it to 0. Writing 0 has no effect.
Port_event	1	R/W	0	Set to 1 when the Int_enable bit in the register map of each port is 1 and there is a change in the ports connected, Bias, Disabled and Fault bits. Set to 1 when the Watchdog bit is 1 and any one port does resume. Writing 1 to this bit clears it to 0. Writing 0 has no effect.

Enab_accel	1	R/W	0	Enables arbitration acceleration.
				Ack-acceleration and Fly-by arbitration are enabled.
				    1: Enabled
				    0: Disabled
				If this bit changes while the bus request is pending, the operation is not guaranteed.

Enab_multi	1	R/W	0	Enable multi-speed packet concatenation. Setting this bit to 1 follows multi-speed transmission. When this bit is set to 0,the packet will be transmitted with the same speed as the first packet.

Page_select	3	R/W	000	Select page address between 1000 to 1111.
				    000: Port Status Page
				    001: Vendor ID Page
				    111: Vendor Dependent Page
				    Others: Unused

Port_select	4	R/W	0000	Port Selection.
				Selecting 000 (Port Status Page) with the Page_select selects the port.
				Selecting 111 (Vendor Dependent Page) with the Page_select have to select the Port 1.
				    0000: Port 0
				    0001: Port 1
				    0010: Port 2
				    Others: Unused

Reserved	-	R	000…	Reserved. Read as 0.

2.2 Port Status Page (Page 000)

Figure 2-2. Port Status Page

	0	1	2	3	4	5	6	7
1000	AStat		BStat		Child	Connected	Bias	Disabled
1001	Negotiated_speed			Int_enable	Fault	Reserved		
1010	Reserved							
1011	Reserved							
1100	Reserved							
1101	Reserved							
1110	Reserved							
1111	Reserved							

Table 2-2. Bit Field Description

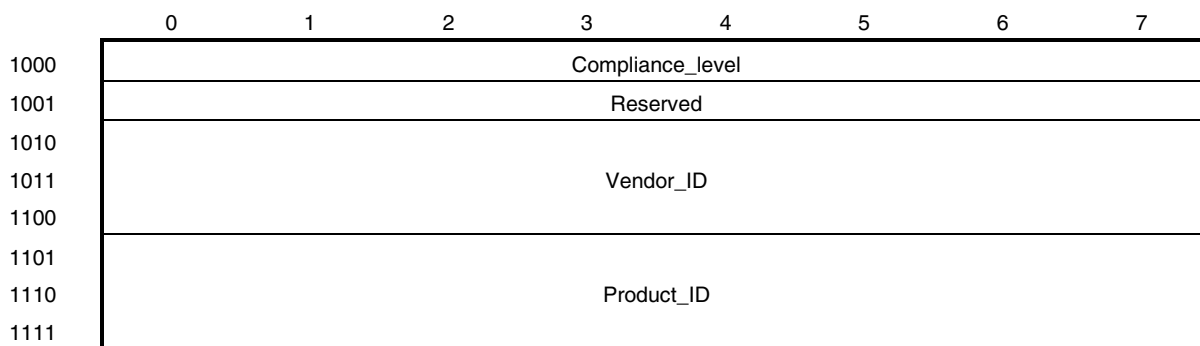| Field	Size	R/W	Reset value	Description
AStat	2	R	XX	A port status value. 00: invalid, 10: "0" 01: "1", 11: "Z"
BStat	2	R	XX	B port status value. 00: invalid, 10: "0" 01: "1", 11: "Z"
Child	1	R		Child node status value. 1: Connected to child node 0: Connected to parent node
Connected	1	R	0	Connection status value. 1: Connected 0: Disconnected
Bias	1	R		Bias voltage status value. 1: Bias voltage 0: No bias voltage
Disabled	1	R/W	See Description	The reset value is set to 0: Enabled.
Negotiated_Speed	3	R		Shows the maximum data transfer rate of the node connected to this port. 000: 100 Mbps 001: 200 Mbps 010: 400 Mbps
Int_enable	1	R/W	0	When set to 1, the Port_event is set to 1 if any of this port's Connected, Bias, Disabled or Fault bits change state.
Fault	1	R/W	0	Set to 1 if an error occurs during Suspend/Resume. Writing 1 to this bit clears it to 0. Writing 0 has no effect.
Reserved	-	R	000…	Reserved. Read as 0.

2.3 Vendor ID Page (Page 001)

Figure 2-3. Vendor ID Page

	0	1	2	3	4	5	6	7
1000	Compliance_level							
1001	Reserved							
1010	Vendor_ID							
1011								
1100								
1101	Product_ID							
1110								
1111								

Table 2-3. Bit Field Description

Field	Size	R/W	Reset value	Description
Compliance_level	8	R	00000001	According to IEEE1394a-2000.
Vendor_ID	24	R	00004CH	Company ID Code value, NEC IEEE OUI.
Product_ID	24	R		Product code.
Reserved	-	R	000…	Reserved. Read as 0.

2.4 Vendor Dependent Page (Page 111 : Port_select 0001)
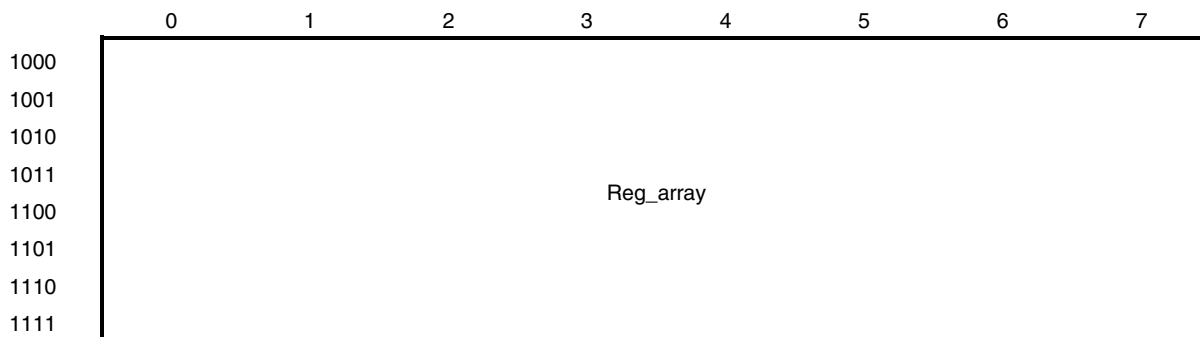
Figure 2-4. Vendor Dependent Page

	0	1	2	3	4	5	6	7
1000	Reg_array							
1001								
1010								
1011								
1100								
1101								
1110								
1111								

Table 2-4. Bit Field Description

Field	Size	R/W	Reset value	Description
Reg_array	64	R/W	0	This register array is possible R/W.

3. CONFIGURATION REGISTERS

3.1 PCI Bus Mode Configuration Register (CARD_ON = Low)

31 24	23 16	15 08	07 00	
Device ID		Vendor ID		00H
Status		Command		04H
Class Code			Revision ID	08H
BIST	Header Type	Latency Timer	Cache Line Size	0CH
Base Address 0				10H
Reserved				14H
Reserved				18H
Reserved				1CH
Reserved				20H
Reserved				24H
Reserved				28H
Subsystem ID		Subsystem Vendor ID		2CH
Reserved				30H
Reserved			Cap_Ptr	34H
Reserved				38H
Max_Lat	Min_Gnt	Interrupt Pin	Interrupt Line	3CH
PCI_OHCI_Control				40H
Reserved				44H
Reserved				48H
Reserved				4CH
Reserved				50H
Reserved				54H
Reserved				58H
Reserved				5CH
Power Management Capabilities		Next_Item_Ptr	Cap_ID	60H
Reserved		Power Management Control/Status		64H
Reserved				68H FCH

3.1.1 Offset_00   Vendor ID Register
This register identifies the manufacturer of the μPD72874. The ID is assigned by the PCI_SIG committee.

Bits	R/W	Description
15-0	R	Constant value of 1033H.

3.1.2 Offset_02   Device ID Register
This register identifies the type of the device for the μPD72874. The ID is assigned by NEC Corporation.

Bits	R/W	Description
15-0	R	Constant value of 00F2H.

3.1.3 Offset_04   Command Register
The register provides control over the device's ability to generate and respond to PCI cycles.

Bits	R/W	Description
0	R	**I/O enable** Constant value of 0. The μPD72874 does not respond to PCI I/O accesses.
1	R/W	**Memory enable** Default value of 1. It defines if the μPD72874 responds to PCI memory accesses. This bit should be set to one upon power-up reset. 0: The μPD72874 does not respond to PCI memory cycles 1: The μPD72874 responds to PCI memory cycles
2	R/W	**Master enable** Default value of 1. It enables the μPD72874 as bus-master on the PCI-bus. 0: The μPD72874 cannot generate PCI accesses by being a bus-master 1: The μPD72874 is capable of acting as a bus-master
3	R	**Special cycle monitor enable** Constant value of 0. The special cycle monitor is always disabled.
4	R/W	**Memory write and invalidate enable** Default value of 0. It enables Memory Write and Invalid Command generation. 0: Memory write must be used 1: The μPD72874, when acts as PCI master, can generate the command
5	R	**VGA^{TM} color palette invalidate enable** Constant value of 0. VGA color palette invalidate is always disabled.
6	R/W	**Parity error response** Default value of 0. It defines if the μPD72874 responds to $\overline{\text{PERR}}$. 0: Ignore parity error 1: Respond to parity error
7	R	**Stepping enable** Constant value of 0. Stepping is always disabled.
8	R/W	**System error enable** Default value of 0. It defines if the μPD72874 responds to $\overline{\text{SERR}}$. 0: Disable system error checking 1: Enable system error checking
9	R	**Fast back-to-back enable** Constant value of 0. Fast back-to-back transactions are only allowed to the same agent.
15-10	R	**Reserved** Constant value of 000000.

3.1.4 Offset_06 Status Register

This register tracks the status information of PCI-bus related events which are relevant to the μPD72874. "Read" and "Write" are handled somewhat differently.

Bits	R/W	Description
3-0	R	**Reserved** Constant value of 0000.
4	R	**New capabilities** Constant value of 1. It indicates the existence of the Capabilities List.
6,5	R	**Reserved** Constant value of 00.
7	R	**Fast back-to-back capable** Constant value of 1. It indicates that the μPD72874, as a target, cannot accept fast back-to-back transactions when the transactions are not to the same agent.
8	R/W	**Signaled parity error** Default value of 0. It indicates the occurrence of any "Data Parity". 0: No parity detected (default) 1: Parity detected
10,9	R	**DEVSEL timing** Constant value of 01. These bits define the decode timing for $\overline{\text{DEVSEL}}$. 0: Fast (1 cycle) 1: Medium (2 cycles) 2: Slow (3 cycles) 3: undefined
11	R/W	**Signaled target abort** Default value of 0. This bit is set by a target device whenever it terminates a transaction with "Target Abort". 0: The μPD72874 did not terminate a transaction with Target Abort 1: The μPD72874 has terminated a transaction with Target Abort
12	R/W	**Received target abort** Default value of 0. This bit is set by a master device whenever its transaction is terminated with a "Target Abort". 0: The μPD72874 has not received a Target Abort 1: The μPD72874 has received a Target Abort from a bus-master
13	R/W	**Received master abort** Default value of 0. This bit is set by a master device whenever its transaction is terminated with "Master Abort". The μPD72874 asserts "Master Abort" when a transaction response exceeds the time allocated in the latency timer field. 0: Transaction was not terminated with a Master Abort 1: Transaction has been terminated with a Master Abort
14	R/W	**Signaled system error** Default value of 0. It indicates that the assertion of $\overline{\text{SERR}}$ by the μPD72874. 0: System error was not signaled 1: System error was signaled
15	R/W	**Received parity error** Default value of 0. It indicates the occurrence of any $\overline{\text{PERR}}$. 0: No parity error was detected 1: Parity error was detected

3.1.5 Offset_08 Revision ID Register

This register specifies a revision number assigned by NEC Corporation for the μPD72874.

Bits	R/W	Description
7-0	R	Default value of 01H. It specifies the silicon revision. It will be incremented for subsequent silicon revisions.

3.1.6 Offset_09 Class Code Register

This register identifies the class code, sub-class code, and programming interface of the μPD72874.

Bits	R/W	Description
7-0	R	Constant value of 10H. It specifies an IEEE1394 OHCI-compliant Host Controller.
15-8	R	Constant value of 00H. It specifies an "IEEE1394" type.
23-16	R	Constant value of 0CH. It specifies a "Serial Bus Controller".

3.1.7 Offset_0C Cache Line Size Register

This register specifies the system cache line size, which is PC-host system dependent, in units of 32-bit words. The following cache line sizes are supported: 2, 4, 8, 16, 32, 64, and 128. All other values will be recognized as 0, i.e. cache disabled.

Bits	R/W	Description
7-0	R/W	Default value of 00H.

3.1.8 Offset_0D Latency Timer Register

This register defines the maximum amount of time that the μPD72874 is permitted to retain ownership of the bus after it has acquired bus ownership and initiated a subsequent transaction.

Bits	R/W	Description
7-0	R/W	Default value of 00H. It specifies the number of PCI-bus clocks that the μPD72874 may hold the PCI bus as a bus-master.

3.1.9 Offset_0E Header Type Register

Bits	R/W	Description
7-0	R	Constant value of 00H. It specifies a single function device.

3.1.10 Offset_0F BIST Register

Bits	R/W	Description
7-0	R	Constant value of 00H. It specifies whether the device is capable of Built-in Self Test.

3.1.11 Offset_10   Base Address 0 Register

This register specifies the base memory address for accessing all the "Operation registers" (i.e. control, configuration, and status registers) of the *µ*PD72874, while the BIOS is expected to set this value during power-up reset.

Bits	R/W	Description
11-0	R	Constant value of 000H. These bits are "read-only".
31-12	R/W	-

3.1.12 Offset_2C   Subsystem Vendor ID Register

This register identifies the subsystem that contains the NEC's *µ*PD72874 function. While the ID is assigned by the PCI_SIG committee, the value should be loaded into the register from the external serial ROM after power-up reset. Access to this register through PCI-bus is prohibited.

Bits	R/W	Description
15-0	R	Default value of 1033H.

3.1.13 Offset_2E   Subsystem ID Register

This register identifies the type of the subsystem that contains the NEC's *µ*PD72874 function. While the ID is assigned by the manufacturer, the value should be loaded into the register from the external serial EEPROM after power-up reset. Access to this register through PCI-bus is prohibited.

Bits	R/W	Description
15-0	R	Default value of 00F2H.

3.1.14 Offset_34   Cap_Ptr Register

This register points to a linked list of additional capabilities specific to the *µ*PD72874, the NEC's implementation of the 1394 OHCI specification.

Bits	R/W	Description
7-0	R	Constant value of 60H. The value represents an offset into the *µ*PD72874's PCI Configuration Space for the location of the first item in the New Capabilities Linked List.

3.1.15 Offset_3C   Interrupt Line Register

This register provides the interrupt line routing information specific to the *µ*PD72874, the NEC's implementation of the 1394 OHCI specification.

Bits	R/W	Description
7-0	R/W	Default value of 00H. It specifies which input of the host system interrupt controller the interrupt pin of the *µ*PD72874 is connected to.

3.1.16 Offset_3D   Interrupt Pin Register

This register provides the interrupt line routing information specific to the μPD72874, the NEC's implementation of the 1394 OHCI specification.

Bits	R/W	Description
7-0	R	Constant value of 01H. It specifies PCI INTA is used for interrupting the host system.

3.1.17 Offset_3E   Min_Gnt Register

This register specifies how long of a burst period the μPD72874 needs, assuming a clock rate of 33 MHz. Resolution is in units of ¼ μs. The value should be loaded into the register from the external serial EEPROM upon power-up reset, and access to this register through PCI-bus is prohibited.

Bits	R/W	Description
7-0	R	Default value of 00H. Its value contributes to the desired setting for Latency Timer value.

3.1.18 Offset_3F   Max_Lat Register

This register specifies how often the μPD72874 needs to gain access to the PCI-bus, assuming a clock rate of 33 MHz. Resolution is in units of ¼ μs. The value should be loaded into the register from the external serial EEPROM after hardware reset, and access to this register through PCI-bus is prohibited.

Bits	R/W	Description
7-0	R	Default value of 00H. Its value contributes to the desired setting for Latency Timer value.

3.1.19 Offset_40   PCI_OHCI_Control Register

This register specifies the control bits that are IEEE1394 OHCI specific. Vendor options are not allowed in this register. It is reserved for OHCI use only.

Bits	R/W	Description
0	R/W	**PCI global SWAP** Default value of 0. When this bit is 1, all quadrates read from and written to the PCI Interface are byte swapped, thus a "PCI Global Swap". PCI addresses for expansion ROM and PCI Configuration registers, are, however, unaffected by this bit. This bit is not required for motherboard implementations.
31-1	R	**Reserved** Constant value of all 0.

3.1.20 Offset_60   Cap_ID & Next_Item_Ptr Register

The Cap_ID signals that this item in the Linked List is the registers defined for PCI Power Management, while the Next_Item_Ptr describes the location of the next item in the μPD72874's Capability List.

Bits	R/W	Description
7-0	R	**Cap_ID** Constant value of 01H. The default value identified the Link List item as being the PCI Power Management registers, while the ID value is assigned by the PCI SIG.
15-8	R	**Next_Item_Ptr** Constant value of 00H. It indicated that there are no more items in the Link List.

3.1.21 Offset_62   Power Management Capabilities Register

This is a 16-bit read-only register that provides information on the power management capabilities of the μPD72874.

Bits	R/W	Description
2-0	R	**Version** Constant value of 010. The power management registers are implemented as defined in revision 1.1 of PCI Bus Power Management Interface Specification.
3	R	**PME clock** Constant value of 0.
4	R	**Reserved** Constant value of 0.
5	R	**DSI** Constant value of 0.
8-6	R	**Auxiliary Power** Default value of 000. This field reports the Vaux power requirements for the μPD72874. This data is programable from EEPROM. 111 – 375 mA maximum current required for a 3.3 Vaux, 110 – 320 mA maximum current required for a 3.3 Vaux, 101 – 270 mA maximum current required for a 3.3 Vaux, 100 – 220 mA maximum current required for a 3.3 Vaux, 011 – 160 mA maximum current required for a 3.3 Vaux, 010 – 100 mA maximum current required for a 3.3 Vaux, 001 – 55 mA maximum current required for a 3.3 Vaux, 000 – 0 (self powered)
9	R	**D1_support** Constant value of 1. The μPD72874 supports the D1 Power Management state.
10	R	**D2_support** Constant value of 1. The μPD72874 supports the D2 Power Management state.
15-11	R	**PME_support** D3SUP = 'High' : Constant value of 11111. D3SUP = 'Low' : Constant value of 01111. This field indicates the power states in which the μPD72874 may assert $\overline{\text{PME}}$. A value of "0" for any bit indicates that the function is not capable of asserting the $\overline{\text{PME}}$ signal while in that power state. bit (11) – PME_D0. $\overline{\text{PME}}$ can be asserted from D0. bit (12) – PME_D1. $\overline{\text{PME}}$ can be asserted from D1. bit (13) – PME_D2. $\overline{\text{PME}}$ can be asserted from D2. bit (14) – PME_D3hot. $\overline{\text{PME}}$ can be asserted from D3hot. bit (15) – PME_D3cold. $\overline{\text{PME}}$ can be asserted from D3cold.

3.1.22 Offset_64   Power Management Control/Status Register
This is a 16-bit register that provides control status information of the μPD72874.

Bits	R/W	Description

1,0	R/W	**PowerState** Default value is undefined. This field is used both to determine the current power state of the μPD72874 and to set the μPD72874 into a new power state.
		  00: D0 (DMA contexts: ON, Link Layer: ON, PME will be asserted upon INTA being active.)
		  01: D1 (DMA contexts: OFF, Link Layer: ON, PME will be asserted upon INTA being active)
		  10: D2 (DMA contexts: OFF, Link Layer: OFF, LPS: OFF, PME will be asserted upon LinkON being active)
		  11: D3 (DMA contexts: OFF, Link Layer: OFF, LPS: OFF, PME will be asserted upon LinkON being active)
		The LPS is a PHY/Link interface signal and is defined in P1394a-2000. It is an internal signal in the μPD72874.

7-2	R	**Reserved** Constant value of 000000.
8	R/W	**PME_En** Default value of 0. This field is used to enable the specific power management features of the μPD72874.
12-9	R	**Data_Select** Constant value of 0000.
14,13	R	**Data_Scale** Constant value of 00.
15	R/W	**PME_Status** Default value is undefined. A write of '1' clears this bit, while a write of '0' is ignored.

3.2 CardBus Mode Configuration Register (CARD_ON = High)

31	24	23	16	15	08	07	00	
Device ID				Vendor ID				00H
Status				Command				04H
Class Code						Revision ID		08H
BIST		Header Type		Latency Timer		Cache Line Size		0CH
Base Address 0								10H
Base Address 1 (Cardbus Status Reg) Note								14H
Base Address 2 (Cardbus Status Reg) Note								18H
Reserved								1CH
Reserved								20H
Reserved								24H
Cardbus CIS Pointer Note								28H
Subsystem ID				Subsystem Vendor ID				2CH
Reserved								30H
Reserved						Cap_Ptr		34H
Reserved								38H
Max_Lat		Min_Gnt		Interrupt Pin		Interrupt Line		3CH
PCI_OHCI_Control								40H
Reserved								44H
Reserved								48H
Reserved								4CH
Reserved								50H
Reserved								54H
Reserved								58H
Reserved								5CH
Power Management Capabilities				Next_Item_Ptr		Cap_ID		60H
Reserved				Power Management Control/Status				64H
Reserved								68H
Reserved								6CH
Reserved								70H
Reserved								74H
Reserved								78H
Reserved								7CH
CIS Area Note								80H FCH

Note Different from PCI Bus Mode Configuration Register.

3.2.1 Offset_14/18   Base Address 1/2 Register (Cardbus Status Registers)

Bits	R/W	Description
7-0	R	Constant value of 00.
31-8	R/W	-

(1) Function Event Register (FER) (Base Address 1 (2) + 0H)

Bits	R/W	Description
0	R	Write Protect (No Use). Read only as '0'
1	R	Ready Status (No Use). Read only as '0'
2	R	Battery Voltage Detect 2 (No Use). Read only as '0'
3	R	Battery Voltage Detect 1 (No Use). Read only as '0'
4	R/W	General Wake Up
14-5	R	Reserved. Read only as '0'
15	R/W	Interrupt
31-16	R	Reserved. Read only as '0'

(2) Function Event Mask Register (FEMR) (Base Address 1 (2) + 4H)

Bits	R/W	Description
0	R	Write Protect (No Use). Read only as '0'
1	R	Ready Status (No Use). Read only as '0'
2	R	Battery Voltage Detect 2 (No Use). Read only as '0'
3	R	Battery Voltage Detect 1 (No Use). Read only as '0'
4	R/W	General Wake Up Mask
5	R	BAM. Read only as '0'
6	R	PWM. Read only as '0'
13-7	R	Reserved. Read only as '0'
14	R/W	Wake Up Mask
15	R/W	Interrupt
31-16	R	Reserved. Read only as '0'

(3) Function Reset Status Register (FRSR) (Base Address 1 (2) + 8H)

Bits	R/W	Description
0	R	Write Protect (No Use). Read only as '0'
1	R	Ready Status (No Use). Read only as '0'
2	R	Battery Voltage Detect 2 (No Use). Read only as '0'
3	R	Battery Voltage Detect 1 (No Use). Read only as '0'
4	R/W	General Wake Up Mask
14-5	R	Reserved. Read only as '0'
15	R/W	Interrupt
31-16	R	Reserved. Read only as '0'

(4) Function Force Event Register (FFER) (Base Address 1 (2) + CH)

Bits	R/W	Description
0	R	Write Protect (No Use). Read only as '0'
1	R	Ready Status (No Use). Read only as '0'
2	R	Battery Voltage Detect 2 (No Use). Read only as '0'
3	R	Battery Voltage Detect 1 (No Use). Read only as '0'
4	R/W	General Wake Up Mask
14-5	-	No Use
15	R/W	Interrupt
31-16	R	Reserved. Read only as '0'

3.2.2 Offset_28   Cardbus CIS Pointer

This register specifies start memory address of the Cardbus CIS Area.

Bits	R/W	Description
31-0	R	Starting Pointer of CIS Area. Constant value of 00000080H.

3.2.3 Offset_80   CIS Area

The μPD72874 supports external Serial ROM (AT24C02 compatible) interface.

CIS Area Register can be loaded from external Serial ROM in the CIS area when CARD_ON is 1.

4. PHY FUNCTION

4.1 Cable Interface

4.1.1 Connections

Figure 4-1. Cable Interface
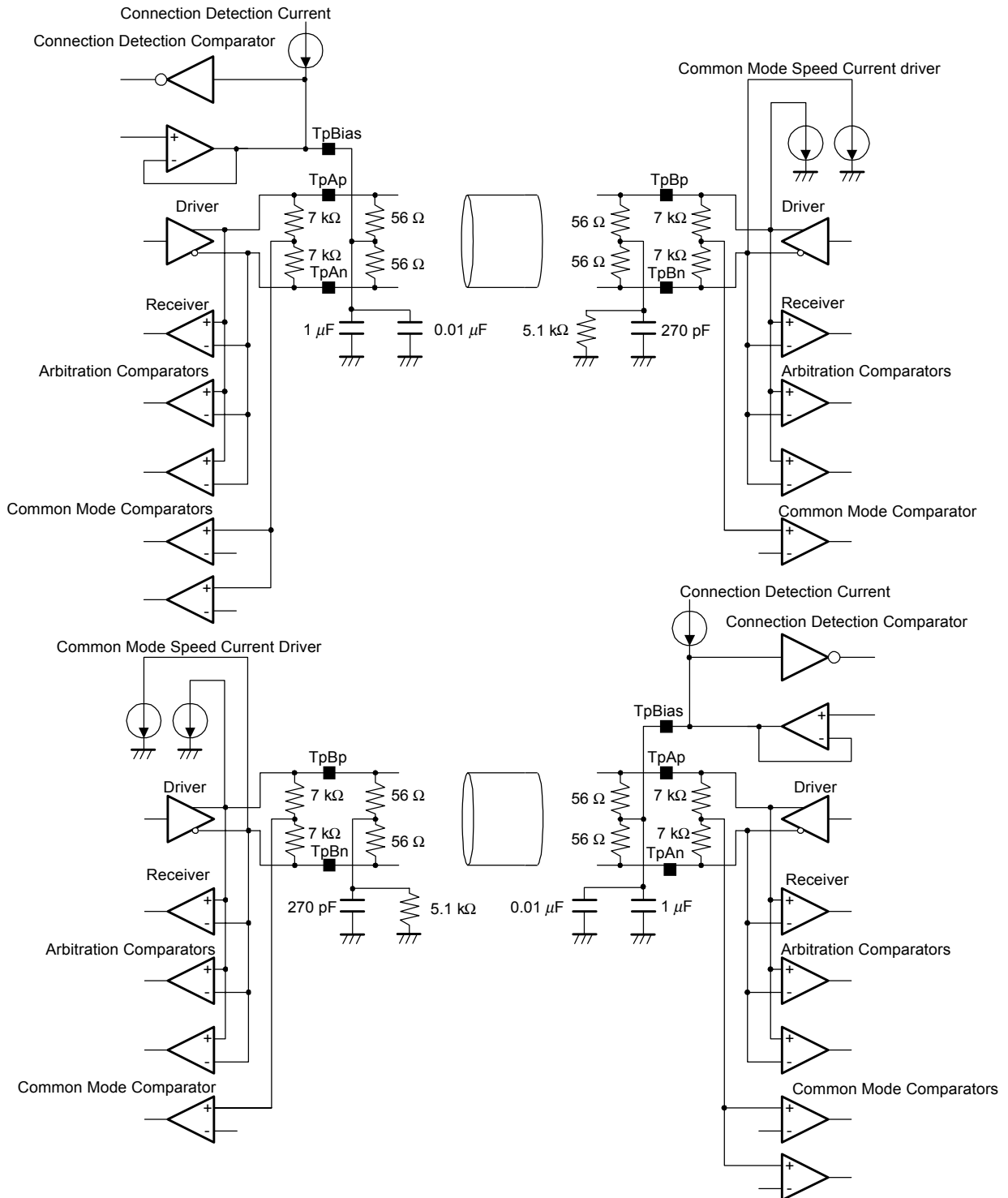
4.1.2 Cable Interface Circuit

Each port is configured with two twisted-pairs of TpA and TpB.

TpA and TpB are used to monitor the state of the Transmit/Receive line, control signals, data and cables.

During transmission to the IEEE1394 bus, the Data/Strobe signal received from the Link layer controller is encoded, converted from parallel to serial and transmitted.

While receiving from the IEEE1394 bus, the Data/Strobe signal from TpA, TpB is converted from serial to parallel after synchronization by SCLK **Note**, then transmitted to the Link layer controller in 2/4/8 bits according to the data rate of 100/200/400 Mbps.

The bus arbitration for TpA and TpB and the state of the line are monitored by the built-in comparator. The state of the 1394 bus is transmitted to the state machine in the LSI.

Note The SCLK is a PHY/Link interface signal and is defined in P1394a-2000. It is an internal signal in the μPD72874.

4.1.3 CPS

Connect an external resistor of 390 kΩ between the CPS pin and the power cable, and an external resistor of 100 kΩ between the CPS pin and the GND to monitor the power of the power cable.

If the cable power falls under 7.5 V there is an indication to the Link layer that the power has failed.

4.1.4 Unused Ports

TpAp, TpAn : Not connected
TpBp, TpBn : AGND
TpBias   : Not connected

4.2 PLL and Crystal Oscillation Circuit

4.2.1 Crystal Oscillation Circuit

To supply the clock of 24.576 MHz ± 100 ppm, use an external capacitor of 10 pF and a crystal of 50 ppm.

4.2.2 PLL

The crystal oscillator multiplies the 24.576 MHz frequency by 16 (393.216 MHz).

4.3 PC0 to PC2

The PC0 to PC2 pin corresponds to the power field of the Self_ID packet and Pwr_class in the PHY register. Refer to Section 4.3.4.1 of the IEEE1394-1995 specification for information regarding the Pwr_class. The value of Pwr can be changed with software through the Link layer; this pin sets the initial value during Power-on Reset. Use a pull-up or pull-down resistor of 1 kΩ based on the application.

4.4 $\overline{\text{P\_RESET}}$

Connect an external capacitor of 0.1 μF between the pins $\overline{\text{P\_RESET}}$ and GND. If the voltage drops below 0 V, a reset pulse is generated. All of the circuits are initialized, including the contents of the PHY register.

4.5 RI0, RI1

Connect an external resistor of 9.1 kΩ ± 0.5 % to limit the LSI's current.

5. ELECTRICAL SPECIFICATIONS

Absolute Maximum Ratings

Parameter	Symbol	Condition	Rating	Unit
Power supply voltage	V_{DD}		−0.5 to +4.6	V
Input voltage	V_I	LVTTL @ $(V_I < 0.5 \text{ V} + V_{DD})$	−0.5 to +4.6	V
		PCI @ $(V_I < 3.0 \text{ V} + V_{DD})$	−0.5 to +6.6	V
Output voltage	V_O	LVTTL @ $(V_O < 0.5 \text{ V} + V_{DD})$	−0.5 to +4.6	V
		PCI @ $(V_O < 3.0 \text{ V} + V_{DD})$	−0.5 to +6.6	V
Operating ambient temperature	T_A		0 to +70	°C
Storage temperature	T_{stg}		−65 to +150	°C

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

Recommended Operating Ranges

Parameter	Symbol	Condition	Rating	Unit
Power supply voltage	V_{DD}	Used to clamp reflection on PCI bus.	4.5 to 5.5	V
			3.0 to 3.6	V
Operating ambient temperature	T_A		0 to +70	°C

DC Characteristics (V$_{DD}$ = 3.3 V ± 10 %, V$_{SS}$ = 0 V, T$_A$ = 0 to +70°C)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
High-level input voltage	V$_{IH}$		2.0		V$_{DD}$+0.5	V
Low-level input voltage	V$_{IL}$		−0.5		+0.8	V
High-level output current	I$_{OH}$	V$_{OH}$ = 2.4 V, GROM_SDA, GROM_SCL	−6			mA
Low-level output current	I$_{OL}$	V$_{OL}$ = 0.4 V, GROM_SDA, GROM_SCL	6			mA
Input leakage current	I$_L$	V$_{IN}$ = V$_{DD}$ or GND			±10.0	*µ*A
PCI interface						
High-level input voltage	V$_{IH}$		2.0		5.5	V
Low-level input voltage	V$_{IL}$		−0.5		+0.8	V
High-level output current	I$_{OH}$	V$_{OH}$ = 2.4 V	−2			mA
Low-level output current	I$_{OL}$	V$_{OL}$ = 0.4 V	9			mA
Input leakage current	I$_L$	V$_{IN}$ = V$_{DD}$ or GND			±10.0	*µ*A
Cable interface						
Differential input voltage	V$_{ID}$	Cable input, 100 Mbps operation	142		260	mV
		Cable input, 200 Mbps operation	132		260	mV
		Cable input, 400 Mbps operation	118		260	mV
TpB common mode input voltage	V$_{ICM}$	100 Mbps speed signaling off	1.165		2.515	V
		200 Mbps speed signaling	0.935		2.515	V
		400 Mbps speed signaling	0.523		2.515	V
Differential output voltage	V$_{OD}$	Cable output (Test load 55 Ω)	172.0		265.0	mV
TpA common mode output voltage	V$_{OCM}$	100 Mbps speed signaling off	1.665		2.015	V
		200 Mbps speed signaling	1.438		2.015	V
		400 Mbps speed signaling	1.030		2.015	V
TpA common mode output current	I$_{CM}$	100 Mbps speed signaling off	−0.81		+0.44	mA
		200 Mbps speed signaling	−4.84		−2.53	mA
		400 Mbps speed signaling	−12.40		−8.10	mA
Power status threshold voltage	V$_{TH}$	CPS			7.5	V
TpBias output voltage	V$_{TPBIAS}$		1.665		2.015	V

Remarks 1. Digital core runs at 3.3 V.

    2. PCI Interface can run at 5 or 3.3 V, depending on the choice of 5 V-PCI or 3.3 V-PCI.

    3. All other I/Os are 3.3 V driving, and 5 V tolerant.

    4. 5 V are used only for 5 V-PCI clamping diode.
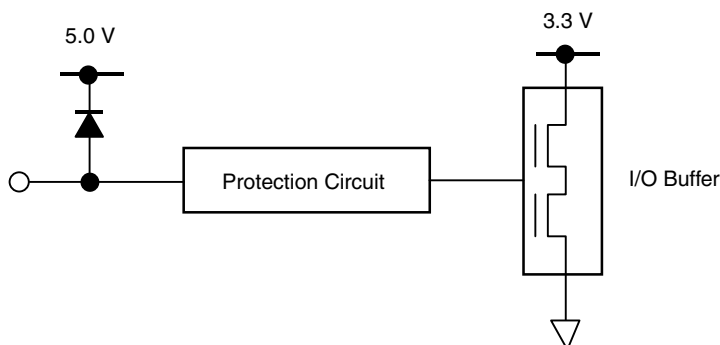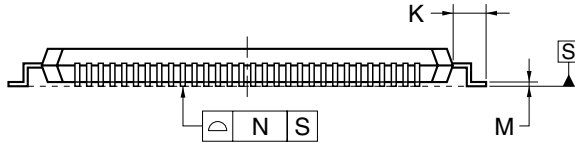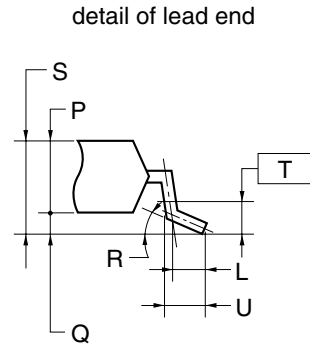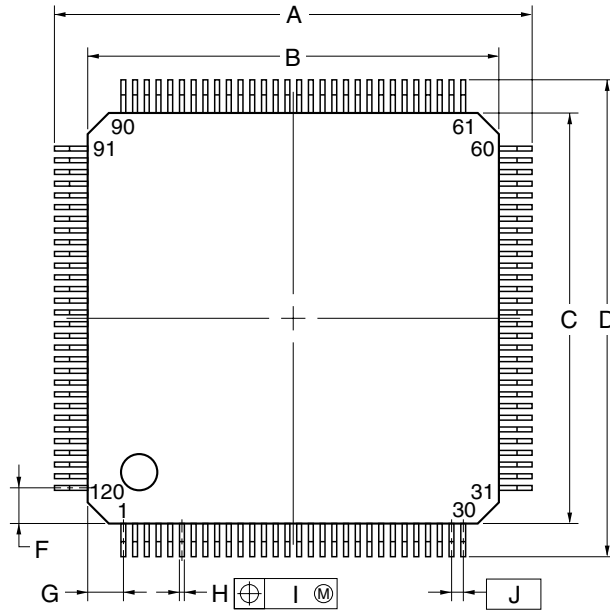
AC Characteristics

PCI Interface
See PCI local bus specification Revision 2.2.

Serial ROM Interface
See AT24C01A/02/04/08/16 Spec. Sheet.

★ **6. PACKAGE DRAWING**

120-PIN PLASTIC TQFP (FINE PITCH) (14x14)

detail of lead end

NOTE

Each lead centerline is located within 0.07 mm of
its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
A	16.00±0.20
B	14.00±0.20
C	14.00±0.20
D	16.00±0.20
F	1.20
G	1.20
H	0.18±0.05
I	0.07
J	0.40 (T.P.)
K	1.00±0.20
L	0.50
M	$0.17^{+0.03}_{-0.07}$
N	0.08
P	1.00±0.05
Q	0.10±0.05
R	$3°^{+4°}_{-3°}$
S	1.20MAX.
T	0.25
	P120GC-40-YEB

7. RECOMMENDED SOLDERING CONDITIONS

The μPD72874 should be soldered and mounted under the following recommended conditions.

For the details of the recommended soldering conditions, refer to the document **Semiconductor Device Mounting Technology Manual (C10535E)**.

For soldering methods and conditions other than those recommended below, contact your NEC sales representative.

Table 7-1. Surface Mounting Type Soldering Conditions

μPD72874GC-YEB: 120-pin plastic TQFP (Fine pitch) (14 x 14)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235°C, Time: 30 sec. Max. (at 210°C or higher). Count: three times or less Exposure limit: 3 days[Note] (after that prebake at 125°C for 10 hours)	IR35-103-3
Partial heating	Pin temperature: 300°C Max., Time: 3 sec. Max. (per pin row)	—

Note After opening the dry pack, store it at 25°C or less and 65% RH or less for the allowable storage period.

[MEMO]

[MEMO]

[MEMO]

--- NOTES FOR CMOS DEVICES ---

① **PRECAUTION AGAINST ESD FOR SEMICONDUCTORS**

Note:

Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

② **HANDLING OF UNUSED INPUT PINS FOR CMOS**

Note:

No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to V_{DD} or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

③ **STATUS BEFORE INITIALIZATION OF MOS DEVICES**

Note:

Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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